

Electronic Patent Application Fee Transmittal

Application Number:	10706977			
Filing Date:	14-Nov-2003			
Title of Invention:	Wafer processing apparatus having dust proof function			
First Named Inventor/Applicant Name:	Tsutomu Okabe			
Filer:	Marvin Jay Spivak/Ian Hall-Hough			
Attorney Docket Number:	245166US3CIP			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 2 months with \$120 paid	1252	1	340	340

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
Total in USD (\$)				1150